## Reference Design Guide

Window Lift

## Design overview

This Infineon Reference Design Guide describes the ECU for a window lift, using the H-Bridge MOSFET driver IC TLE9855QX of the MOTIX ${ }^{\text {TM }}$ ICs family as DC motor controller, in combination with the Halleffect sensor TLE4966G.

Four MOSFETs in S308 package are used to drive the DC motor, replacing the relay used in the standard window lift implementation.

The design is capable to drive loads up to 200W at a battery voltage of 12 V .

This application note contains the description of the design, the schematics and the test reports of the measurements.

The EMC performance is tested according to the CISPR25 standard.

## Highlighted Components

- TLE9855QX
- IPZ40N04S5-3R1
- TLE4966G


## Applications

- Window Lift
- 200W DC Motor for 12 V applications

Highlighted Design Aspects


EMC
optimized


Cost
optimized


Space optimized

Reference design board and Block Diagram
 Window Lift

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## 1 System description

This application note describes the ECU for a window lift working with a DC motor. This solution can be used for similar applications with equal or smaller power consumption. The ECU includes the MOTIX ${ }^{\text {TM }}$ TLE9855QX, member of the Embedded Power IC family. The TLE9855QX combines an Arm ${ }^{\circledR}$ Cortex ${ }^{\oplus}$-M0 microcontroller with application specific modules like an integrated H-Bridge MOSFET driver, power supply and LIN transceiver. In combination with the OptiMOS ${ }^{\text {TM }}-5$ S308 MOSFETs, the ECU is optimized in terms of PCB size for this power class. The focus of the reference design is to use standard PCB materials and processes.

### 1.1 Design specifications

| Parameter | Symbol | Values |  |  | Unit | Comment |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |
| System Parameters |  |  |  |  |  |  |
| Input voltage | $\mathrm{V}_{1 \times}$ | -0.3 | 12 | 40 | V | P_1.1.1 (TLE9855QX) |
| Functional input voltage | $\mathrm{V}_{\text {IN }}$ | 7 | 12 | 18 | V | According to window lift requirements |
| Peak input current | 1 IN | - | - | 15 | A | Peak current (<10 s) |
| Nominal input current | $I_{\text {IN }}$ | - | 10 | 15 | A | Specified for design |
| LIN interface | $\mathrm{V}_{\text {LI }}$ | -28 | 12 | 40 | V | P_1.1.7 (TLE9855QX) |
| Thermal |  |  |  |  |  |  |
| Operating temperature | TA | -40 | 25 | 125 | ${ }^{\circ} \mathrm{C}$ | Specified for design |
| Electromagnetic Compatibility |  |  |  |  |  |  |
| Conducted emissions |  |  |  | Class 5 |  | CISPR25, $150 \mathrm{kHz}-108 \mathrm{MHz}$ |
| Mechanical Specification |  |  |  |  |  |  |
| PCB dimensions | $60 \mathrm{~mm} \times 48 \mathrm{~mm}(\mathrm{~W} \times \mathrm{H})$ : main PCB $37 \mathrm{~mm} \times 9 \mathrm{~mm}(\mathrm{~W} \times \mathrm{H})$ : PCB side for sensor connection | $60 \mathrm{~mm} \times 48 \mathrm{~mm}(\mathrm{~W} \times \mathrm{H})$ : main PCB |  |  |  |  |



Figure 1 View of the ECU reference design, from top and bottom side

### 1.2 Highlighted products

### 1.2.1 OptiMOS ${ }^{\text {TM }}-540$ V S3O8 (PG-TSDSON-8-33) MOSFET

The S308 package offers high current capability of 40 A with a footprint of $3.3 \times 3.3 \mathrm{~mm}^{2}$. In combination with Infineon leading OptiMOS™ 540 V power MOS technology, the S308 gives ~90\% volume reduction compared to the traditional DPAK package. This enables layout miniaturization for H -Bridge applications, with Infineon wellknown quality level for robust automotive packages. For more information about the product, please visit the Infineon web-page linked below.

- IPZ40N04S5-3R1

Table 1 Automotive TSDSON-8 MOSFET with 40 V OptiMOS ${ }^{\text {TM }}-5$

| Package | Silicon Technology | Product | Max $R_{\text {DS(on) }}$ <br> $[\mathrm{m} \Omega]$ | ID <br> $[\mathrm{A}]$ | QG <br> $[\mathrm{nC}]$ |
| :--- | :--- | :--- | :---: | :---: | :---: |
| S308 <br> (TSDSON-8) | OptiMOS |  |  |  |  |

### 1.2.2 $\quad$ H-Bridge driver IC with integrated arm ${ }^{\circledR}$ Cortex $^{\circledR}$-M0

The MOTIX ${ }^{\text {TM }}$ TLE985x H-Bridge MOSFET driver IC product family is a compact and cost effective SoC for 12 V motor control. It targets automotive applications such as window lift, sunroof, gate lift and pumps.

It integrates a 32-bit Arm ${ }^{\circledR}$ Cortex ${ }^{\circledR}-\mathrm{MO}$ core together with market proven peripherals. It comprises two full duplex serial interfaces (UART) with LIN support, two on-chip temperature and battery voltage measurement units.

The bridge driver of the MOTIX ${ }^{\text {TM }}$ TLE985x implements an adaptive control algorithm, which is able to compensate the MOSFET parameters spread in the system. The algorithm is automatically adjusting the gate current settings based on timing measurements. The advantages of this technique are reduction of EMC (slow slew rates) and power dissipation (short dead times). For more information about the product, please visit the Infineon webpage linked below.

- TLE985x

Table 2 Product Family of H-Bridge Driver IC with Integrated Arm ${ }^{\circledR}$ Cortex ${ }^{\text {® }}$-M0

| Grade | Product | Flash <br> $[\mathrm{kB}]$ | RAM <br> $[\mathrm{kB}]$ | Frequency <br> $[\mathrm{MHz}]$ | Operational <br> Amplifier | $\mathrm{T}_{\text {jmax }}$ <br> $\left[{ }^{\circ} \mathrm{C}\right]$ |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: |
| Grade-1 | TLE9852QX | 48 | 4 | 40 | NO | 150 |
|  | TLE9853QX | 48 | 4 | 40 | YES | 150 |
|  | TLE9854QX | 64 | 4 | 40 | YES | 150 |
|  | TLE9855QX | 96 | 4 | 40 | YES | 150 |
|  | TLE9854QXW | 64 | 4 | 40 | YES | 175 |

### 1.2.3 XENSIV ${ }^{\text {TM }}$ - TLE4966G double Hall-effect sensor

The TLE4966G is an integrated circuit double Hall-effect sensor, designed specifically for highly accurate applications in the automotive sector. Precise magnetic switching points and high temperature stability are
achieved by active compensation circuits and chopper techniques on chip. They provide a speed signal at Q2 for every magnetic pole pair and a direction information at Q1, available before the speed signal. For more information about the product, please visit the Infineon web-page below.

- TLE4966G


Figure 2 TLE4966G Block Diagram

## 2 Toolchain installation

In order to get the board ready and running, the software shown in Table 3 shall be installed.
The $\mu$ Vision software is a development tool provided by Arm ${ }^{\circledR}$ Keil ${ }^{\oplus}$. With code length limitation, the shareware version of the $\mu$ Vision is still able to edit, compile and debug. The Infineon Config Wizard is a tool for configuring peripherals of the Embedded Power IC. The tool can be selected from the pull-down menu of the $\mu$ Vision and helps the user changing parameters from the user interface, generating the software code accordingly. Infineon provides standard motor drive software codes for the Embedded Power IC. They can be downloaded from the Pack Installer within the $\mu$ Vision.

Table 3 Software Toolchain Installation Guide

| Steps | Company | Description |
| :---: | :---: | :---: |
| STEP1 <br> Download and Install <br> Keil ${ }^{\boldsymbol{\mu}} \mathrm{VVision5}$ | Arm ${ }^{\text {Keil }}{ }^{\circ}$ | - Arm ${ }^{\circ}$ Keil ${ }^{\circ} \mu$ Vision is an integrated development environment which consists of code editor, compiler and debugger. <br> - To learn how to use arm ${ }^{\circ}$ Keil ${ }^{\circ} \mu$ Vision 5 , check out our video "Get your motor spinning". |
| STEP2 <br> Download Config Wizard | Infineon Technologies | - Infineon provides the Config Wizard free of charge, which is designed for configuration of chip modules. Config Wizard supports easy configuring of Embedded Power IC peripherals. <br> - Config Wizard can be installed via the Infineon Developer Center. If you don't have the Infineon Developer Center yet, please go to Infineon Development Center and enjoy the release management for updates. |
| STEP3 <br> Download and Install <br> Segger J-Link Driver | SEGGER | - SEGGER J-Link is a widely used driver for "on-board" or "standalone" debugger. |
| STEP4 <br> Download the SDK via $\mu$ Vision5 Pack Installer | Infineon Technologies | - The Embedded Power Software Development Kit (SDK) is a low level driver library, which can be downloaded within Keil ${ }^{\circ}$ $\mu$ Vision via the "Pack Installer" |

For the toolchain installation and free motor drive software, check the following link:
www.infineon.com/embedded-power
For more information about the tool chain installation steps, watch the Infineon video at the following link. Toolchain Installation for Embedded Power ICs / TLE98xx

### 2.1.1 Configuration

To start the configuration, the user shall open a motor drive code project in $\mu$ Vision5, go to "Tools" and then to "Config Wizard". From there, the user can set-up the parameters of the peripherals of TLE985x. Since the Embedded Power IC has a current-source gate driving scheme, the switching speed is not controlled by gate resistors, but by the "Gate Charge/Discharge" parameters in the BDRV tap. For more details about the configuration, please visit the Infineon website of Embedded Power ICs.

Window Lift

## $7 \quad$ Abbreviations and definitions

Table 4 Abbreviations

| Abbreviation | Definition |
| :--- | :--- |
| BDRV | Bridge Driver |
| DC | Direct Current |
| DUT | Device under test |
| ECU | Electronic Control Unit |
| EMC | Electromagnetic Compatibility |
| ESR | Equivalent Series Resistance |
| IC | Integrated Circuit |
| PCB | Local Interconnect Network |
| PWM | Printed Circuit Board |
| RBP | Pulse Width Modulation |
| SoC | Reverse Battery Protection |

## 8 Reference documents

This document should be read in conjunction with the following documents:
[1] TLE9855QX datasheet, Infineon Technologies AG, https://www.infineon.com/dgdl/Infineon-TLE9855QX-DS-DataSheet-v01_00EN.pdf?fileld=5546d462689a790c0169104901f03e18
[2] IPZ40N04S5-3R1 product webpage, Infineon Technologies AG, https://www.infineon.com/cms/de/product/power/mosfet/automotive-mosfet/ipz40n04s5-3r1/
[3] TLE4966G product webpage, Infineon Technologies AG, https://www.infineon.com/cms/en/product/sensor/magnetic-sensors/magnetic-position-sensors/magnetic-switches/tle4966g/?redirld=190241
[4] TLE987x/6x HW Design Guideline, Infineon Technologies AG, https://www.infineon.com/dgdl/Infineon-Z8F80032532_HW Design_Guideline-ApplicationNotes-v01_00EN.pdf?fileld=5546d46275b79adb0175bde698f26102
[5] Reverse polarity protection for Embedded Power ICs, Infineon Technologies AG, https://www.infineon.com/dgdl/Infineon-Reverse Polarity Protection-AN-v01 00EN.pdf?fileld=5546d46267c74c9a01684be08bf45dfb
[6] Benefits of the TLE985x Bridge Driver, Infineon Technologies AG, https://www.infineon.com/dgdl/Infineon-Benefits-of-the-TLE985x-Bridge-Driver-ApplicationNotes-v01_00-EN.pdf?fileld=5546d4626fc1ce0b01700ba331e21b6d
[7] Rise and fall time regulation with current source MOSFET gate drivers, Infineon Technologies AG, https://www.infineon.com/dgdl/Infineon-Z8F69449874-Rise-fall-time-regulation-with-current-source-MOSFET-gate-drivers-ApplicationNotes-v01 00-EN.pdf?fileId=5546d46272e49d2a0172eaac3c9b72fb
[8] Analytical calculation of the RMS current stress on the DC-link capacitor of voltage-PWM converter systems, 2006-07, IEE Proc.-Electr. Power Appl., Vol. 153, No.4.
[9] IPC-2152, 2003-05, Institute for Interconnecting and Packaging Electronic Circuits
[10] IEC 60664-1, 2007-04, International Electrotechnical Commission

## Reference Design Guide

## Revision history

Major changes since the last revision

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| :--- | :--- | :--- |
| 13.05 .2022 | V1.0 | Initial version |

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